Electronic Patent Application Fee Transmittal							
Application Number:	10	10721916					
Filing Date:	24-	24-Nov-2003					
Title of Invention:	FA	FABRICATION METHOD FOR SEMICONDUCTOR PACKAGE HEAT SPREADERS					
First Named Inventor/Applicant Name:	Vir	Virgil Cotoco Ararao					
Filer:	Mil	Mikio Ishimaru/Joana Gunawan					
Attorney Docket Number:	27-	27-006					
Filed as Large Entity							
Utility under 35 USC 111(a) Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
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Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
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Utility Appl issue fee		1501	1	1510	1510		
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